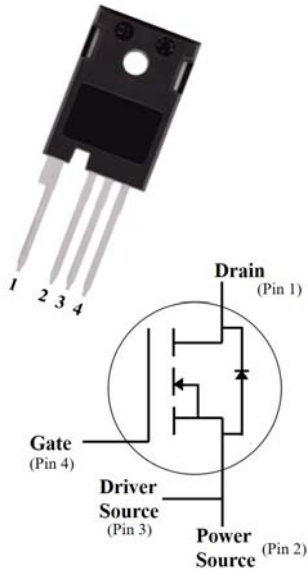


Silicon Carbide Power MOSFET (N-Channel Enhancement)

| | |
|--------------|------|
| V_{DS} | 650V |
| I_D (25°C) | 37A |
| $R_{DS(on)}$ | 60mΩ |



Features

- High speed switching
- Essentially no switching losses
- Reduction of heat sink requirements
- Maximum working temperature at 175 °C
- High blocking voltage
- Fast Intrinsic diode with low recovery current
- High-frequency operation
- Halogen free, RoHS compliant
- AEC-Q101 qualified

Typical Applications

Typical applications are in power factor correction(PFC), solar inverter, uninterruptible power supply, motor drives, photovoltaic inverter, electric car and charger.

Mechanical Data

- **Package:** TO247-4L
- **Terminals:** Tin plated leads
- **Polarity:** As marked

■Maximum Ratings (T_c=25°C Unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | VALUE | TEST CONDITIONS | NOTE |
|--|-----------------------------------|------|---------------|--|---------|
| Device marking code | | | D206560NCFG1Q | | |
| Drain source voltage @ T _j =25°C | $V_{DS,max}$ | V | 650 | $V_{GS}=0\text{ V}, I_D=100\mu\text{A}$ | |
| Gate source voltage @ T _j =25°C | $V_{GS,max}$ | V | -8/+19 | Absolute maximum values | |
| Gate source voltage @ T _j =25°C | $V_{GS,op}$ | V | -4/+15 | Recommended operational values | Note1、2 |
| Continuous drain current @ T _c =25°C | I_D | A | 37 | $V_{GS}=15\text{V}, T_c=25^\circ\text{C}$ | Fig.18 |
| Continuous drain current @ T _c =100°C | | | 28 | $V_{GS}=15\text{V}, T_c=100^\circ\text{C}$ | |
| Pulsed drain current | $I_{D(pulsed)}$ | A | 99 | Pulse width t _p limited by T _{j,max} | Fig.23 |
| Power Dissipation | P_{TOT} | W | 153 | T _c =25°C, T _j = 175°C | Fig.17 |
| Power Dissipation | | | 66 | T _c =110°C, T _j = 175°C | |
| Operating junction and Storage temperature range | T _j , T _{stg} | °C | -55 to +175 | | |
| Soldering temperature | T _L | °C | 260 | 1.6mm (0.063") from case for 10s | |
| Mounting torque | T _M | Nm | 0.6 | M3 screw Maximum of mounting process: 3 | |



YJD206560NCFG1Q

■Static Electrical Characteristics (Tc=25°C unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | Min. | Typ. | Max. | Test Conditions | Note |
|--|----------------------|------|------|------|------|---|-------------|
| Gate threshold voltage | V _{GS(th)} | V | 2.0 | 2.4 | 3.1 | V _{DS} =V _{GS} , I _D =5mA | Fig.4, 11 |
| | | | | 2.0 | | V _{DS} =V _{GS} , I _D =5mA, T _j =175°C | |
| Drain source breakdown voltage | V _{(BR)DSS} | V | 650 | | | V _{GS} =0, I _D =100uA | |
| Zero gate voltage drain current | I _{DSS} | uA | | 1 | 20 | V _{DS} =650V, V _{GS} =0V | Fig.16 |
| Gate source leakage current | I _{GSS} | nA | | | 250 | V _{GS} =15V, V _{DS} =0V | |
| Current drain source on-state resistance | R _{DS ON} | mΩ | | 60 | 79 | V _{GS} =15V, I _D =13.2A | Fig.5, 6, 7 |
| | | | | 90 | | V _{GS} =15V, I _D =13.2A, T _j =175°C | |
| Internal gate resistance | R _g | Ω | | 3 | | f=1MHz | |
| Diode forward voltage | V _{SD} | V | | 5.0 | | V _{GS} =-4V, I _{SD} =6.6A | Fig.8 |
| | | | | 2.8 | | V _{GS} =0V, I _{SD} =6.6A T _j =175°C | Fig.9 |
| Transconductance | g _f | S | | 10 | | V _{DS} =20V, I _D =13.2A | Fig.4 |
| | | | | 9 | | V _{DS} =20V, I _D =13.2A, T _j =175°C | |

■Dynamic Electrical Characteristics (Tc=25°C unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | Min. | Typ. | Max. | Test Conditions | Note |
|---------------------|------------------|------|------|------|------|--|------------|
| Input capacitance | C _{iss} | pF | | 1125 | | V _{DS} =400V, V _{GS} =0V, T _j =25°C, f=100kHz, V _{AC} =25mV | Fig.13, 14 |
| Output capacitance | C _{oss} | | 71 | | | | |
| Reverse capacitance | C _{rss} | | 7 | | | | |
| Coss stored energy | E _{oss} | uJ | | 7 | | | Fig.15 |
| Gate source charge | Q _{gs} | nC | | 13 | | V _{DS} =400V, V _{GS} =-4/15V, I _D =13.2A | Fig.12 |
| Gate drain charge | Q _{gd} | | 17 | | | | |
| Gate charge | Q _g | | 46 | | | | |

■Switching Characteristics (Tc=25°C unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | Min. | Typ. | Max. | Test Conditions | Note |
|---------------------------|---------------------|------|------|------|------|--|------------|
| Turn on switching energy | E _{on} | uJ | | 67 | | V _{DD} =400V, V _{GS} =-4/+15V, I _D =13.2A, R _g =2.5Ω, L=135uH | Fig.21, 22 |
| Turn off switching energy | E _{off} | | 6 | | | | |
| Turn on delay time | t _{d(on)} | ns | | 8 | | | |
| Rise time | t _r | | 11 | | | | |
| Turn off delay time | t _{d(off)} | ns | | 17 | | V _{DD} =400V, V _{GS} =-4/+15V, I _D =13.2A, R _g =2.5Ω, L=135uH | Fig.21, 22 |
| Fall time | t _f | | 5 | | | | |



YJD206560NCFG1Q

■Body diode characteristics (Tc=25°C unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | Min. | Typ. | Max. | Test Conditions | Note |
|----------------------------------|-----------------|------|------|------|------|---|-------|
| Diode forward voltage | V _{SD} | V | | 5.0 | | V _{GS} =-4V, I _{SD} =6.6A | Fig.8 |
| | | | | 2.8 | | V _{GS} =0V, I _{SD} =6.6A T _j =175°C | Fig.9 |
| Continuous diode forward current | I _S | A | | 24 | | V _{GS} =-4V, T _c =25°C | Note1 |
| Reverse recovery time | trr | nS | | 16 | | V _R =400V, V _{GS} =-4V, I _D =13.2A, di/dt=2400A/uS | |
| Reverse recovery charge | Qrr | nC | | 110 | | | |
| Peak reverse recovery current | Irrm | A | | 12 | | | |

Note 1: When using SiC Body Diode the maximum recommended V_{GS} = -4V

Note 2: MOSFET can also safely operate at 0/15 V

■Thermal Characteristics (T_a=25°C Unless otherwise specified)

| PARAMETER | SYMBOL | UNIT | Typ. |
|--------------------|-------------------|------|------|
| Thermal resistance | R _{θJ-C} | °C/W | 0.98 |

■Typical Characteristics

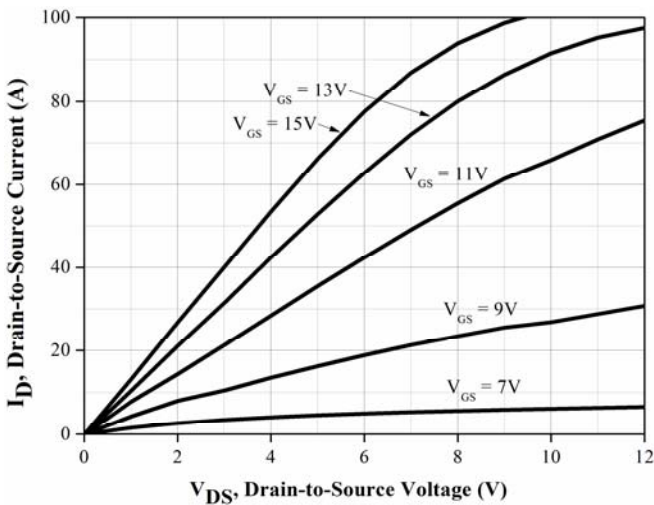


Figure 1. Output Characteristics T_j = -55°C

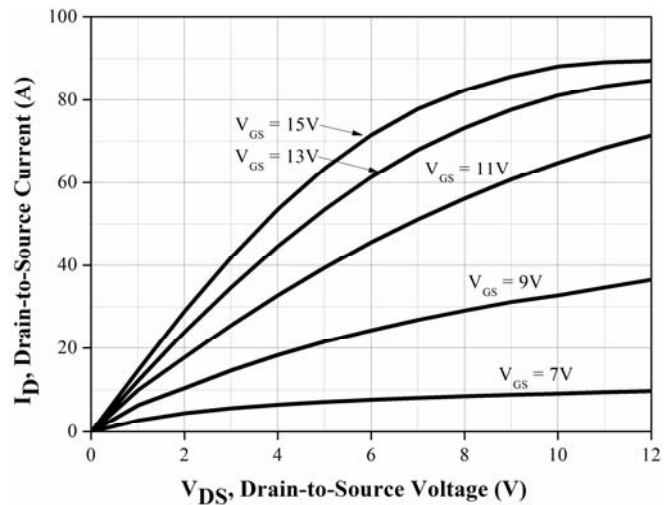


Figure2. Output Characteristics T_j = 25°C



YJD206560NCFG1Q

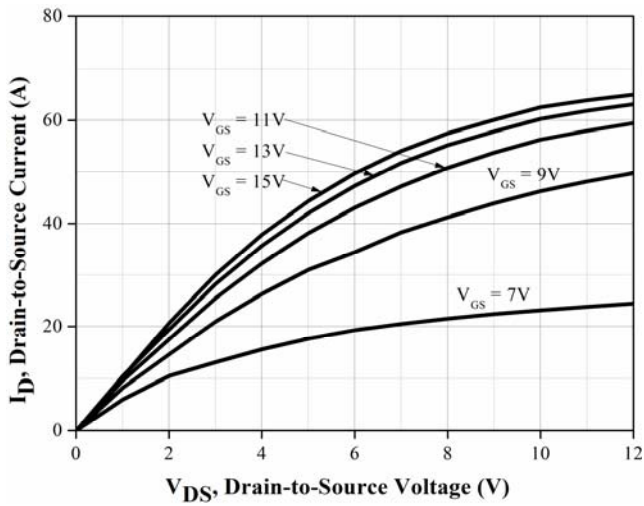


Figure 3. Output Characteristics $T_j = 175^\circ\text{C}$

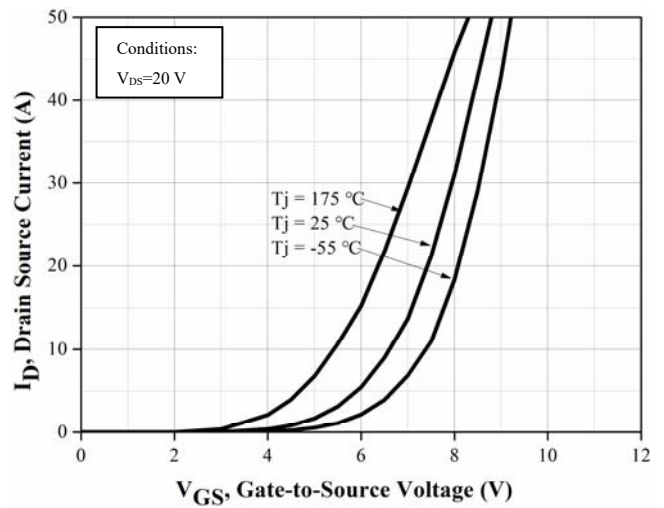


Figure 4. Transfer Characteristics for various junction temperature

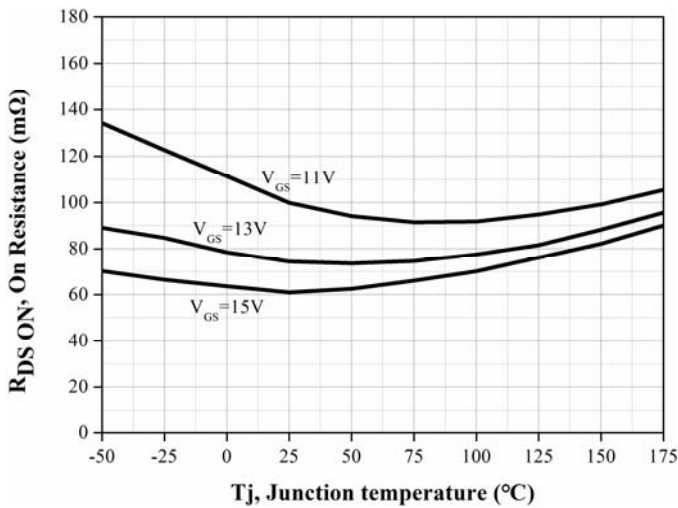


Figure 5. On-resistance vs. temperature for various gate voltage

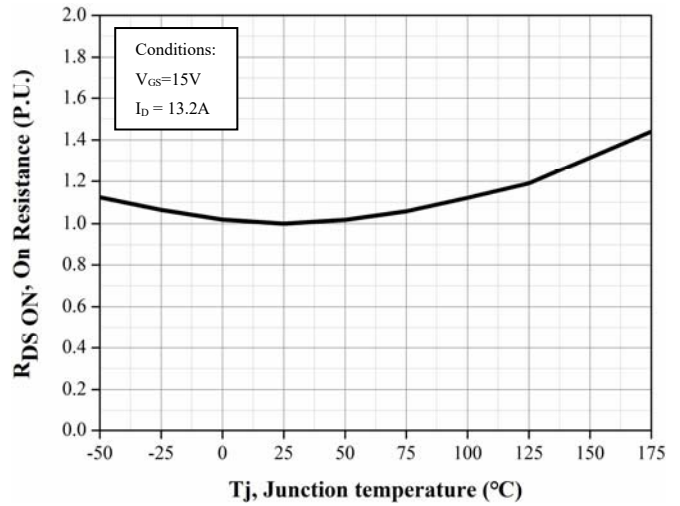


Figure 6. Normalized on-resistance vs. temperature

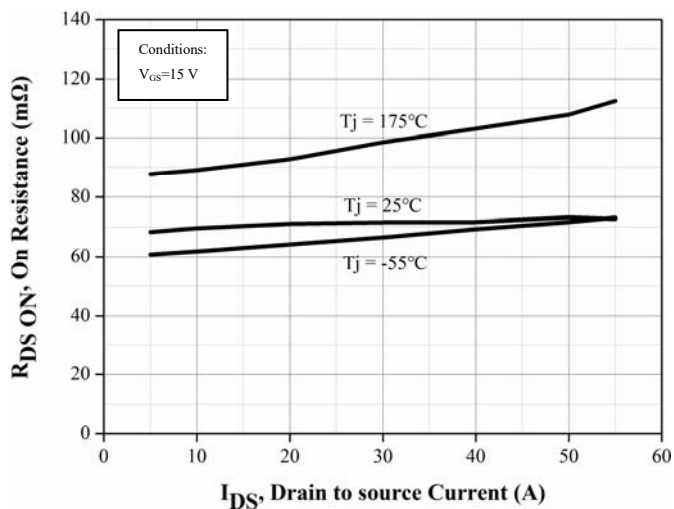


Figure 7. On-resistance vs. drain current

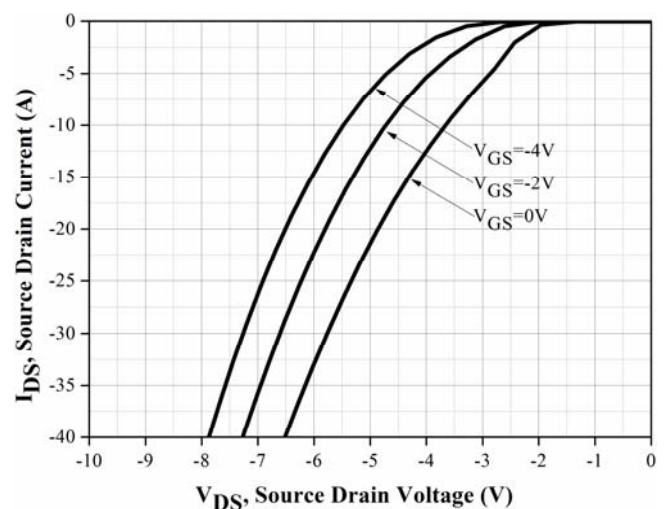


Figure 8. Body diode characteristic at $T_j = 25^\circ\text{C}$



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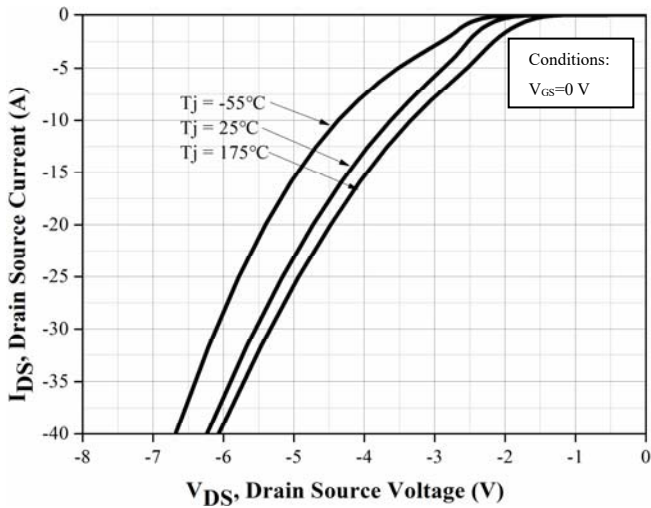


Figure 9. Body diode characteristic

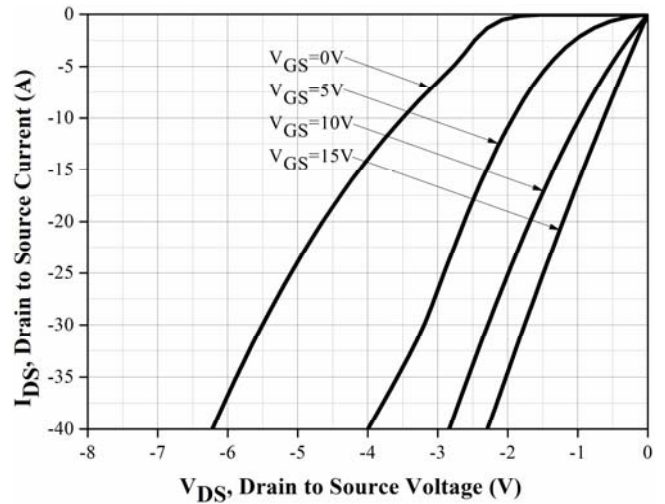


Figure 10. 3rd quadrant characteristic at $T_j = 25^\circ\text{C}$

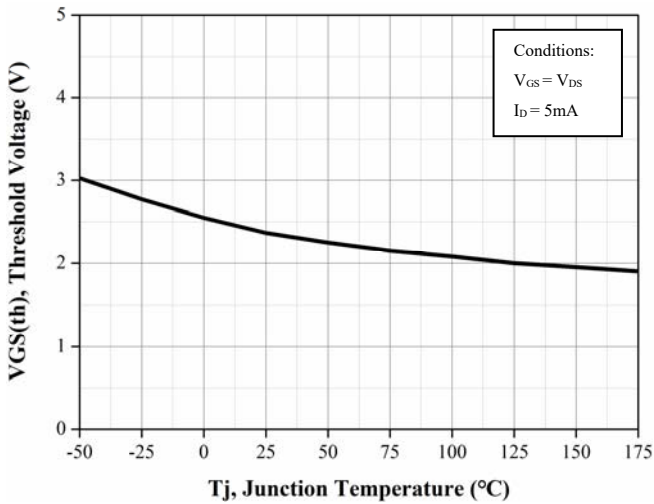


Figure 11. Threshold voltage vs. temperature

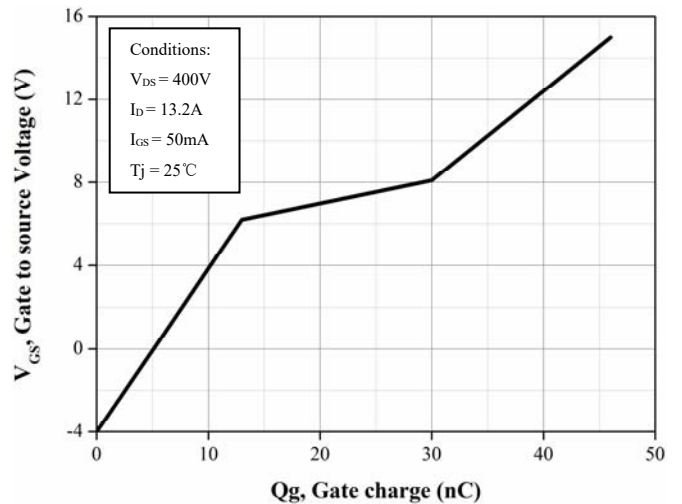


Figure 12. Gate charge characteristic

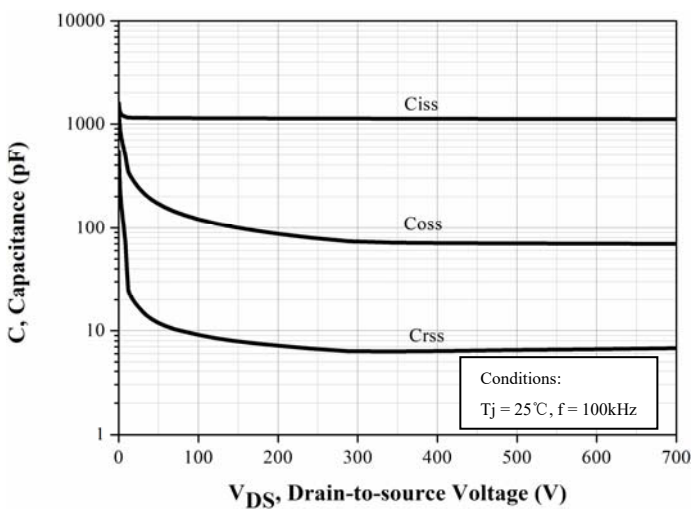


Figure 13. Capacitances vs. drain source voltage (0-700V)

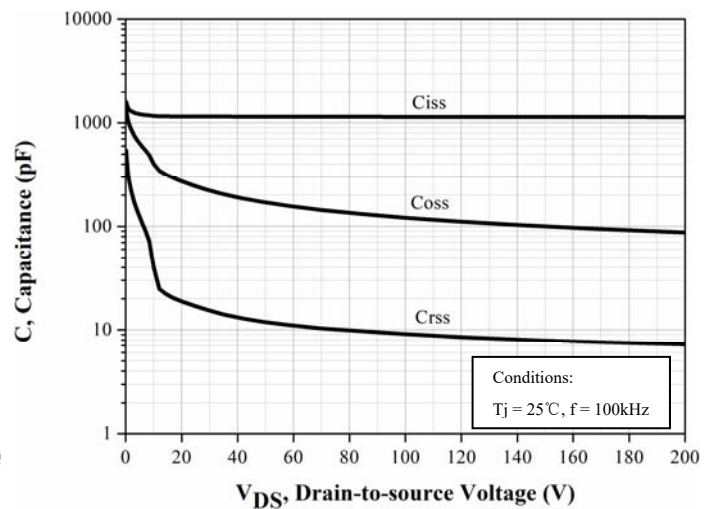


Figure 14. Capacitances vs. drain source voltage (0-200V)



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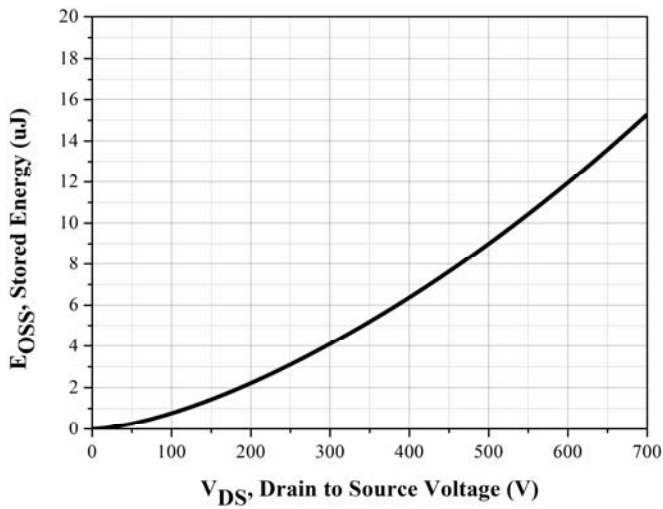


Figure 15. Output capacitor stored energy

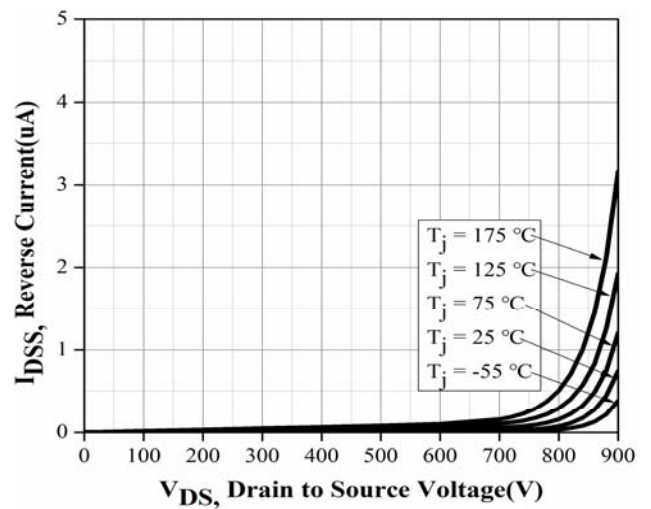


Figure 16. Reverse characteristics vs. Tj

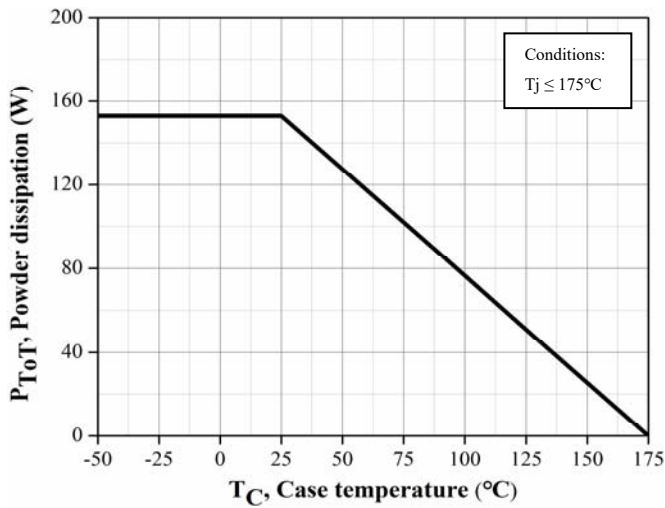


Figure 17. Maximum power dissipation derating vs. case temperature

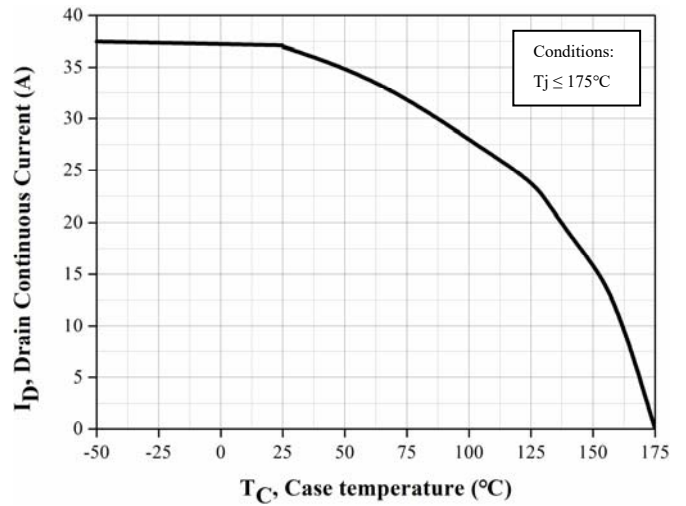


Figure 18. Continuous drain current derating vs. case temperature

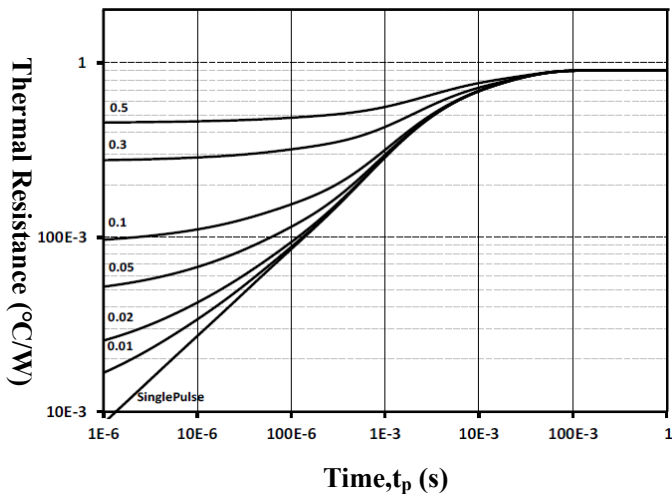


Figure 19. Transient thermal impedance (junction - case)

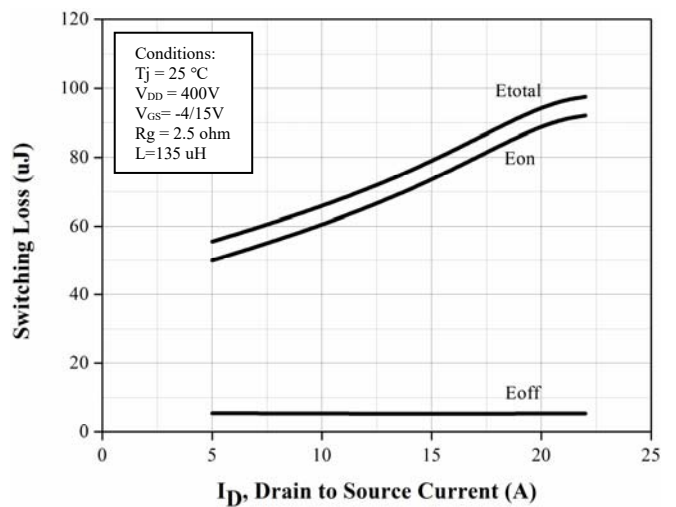


Figure 20. Clamped Inductive switching energy vs. drain current

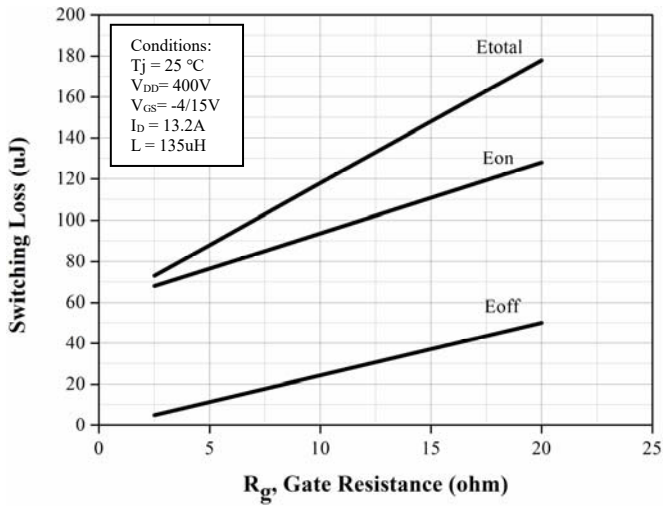


Figure 21. Clamped inductive switching energy vs. R_g

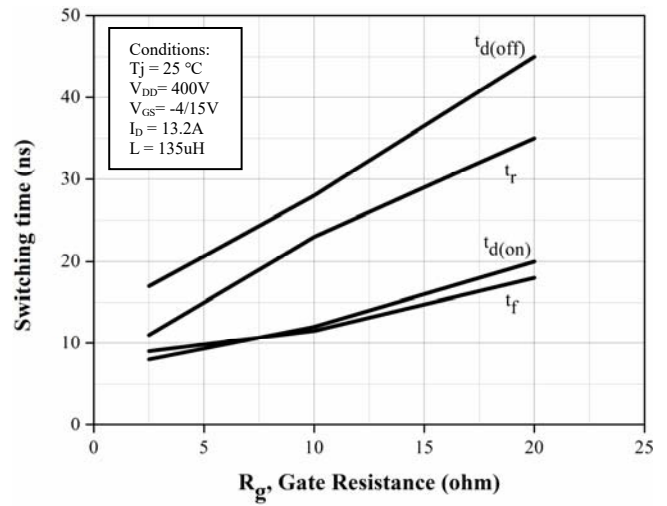


Figure 22. Switching times vs. R_g

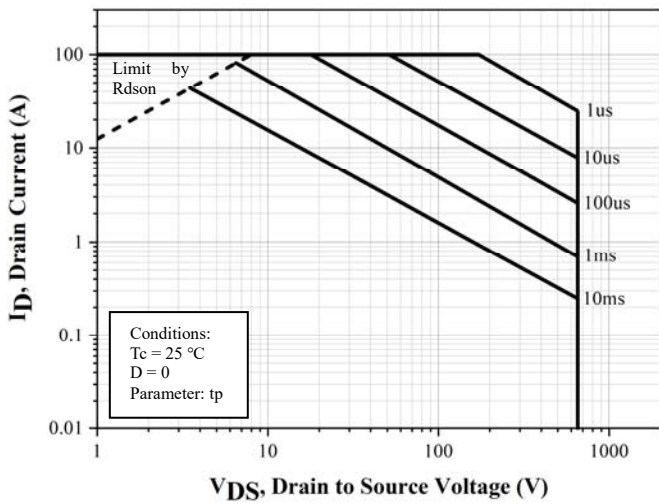


Figure 23. Safe Operating Area

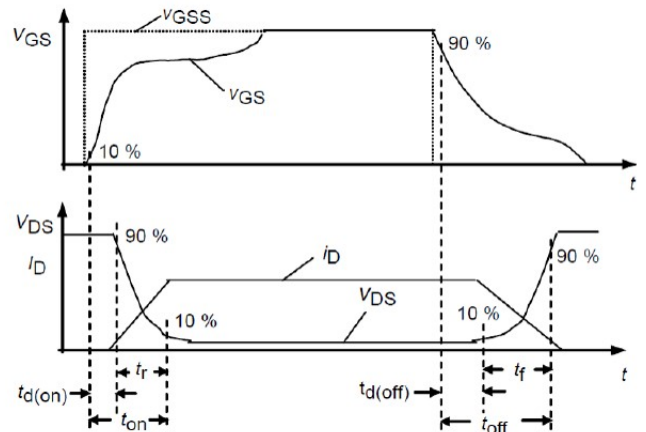


Figure 24. Switching Times Definition

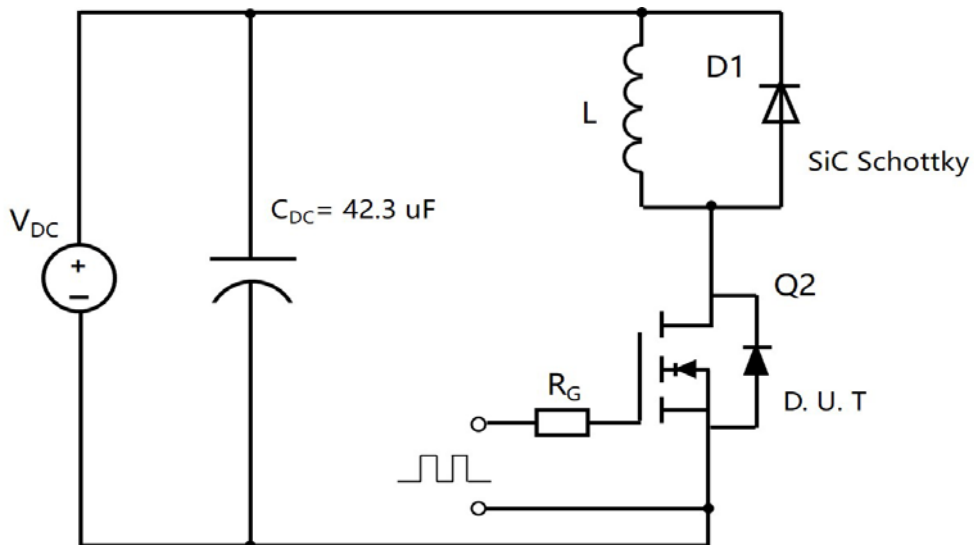
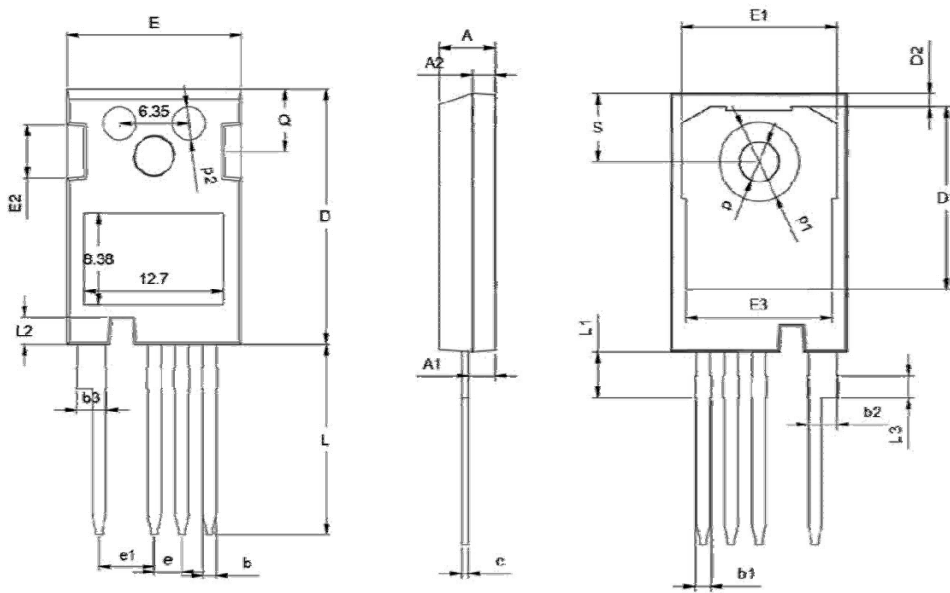


Figure 25. Clamped Inductive Switching Waveform Test Circuit



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■Outline Dimensions



| TO247-4L | | | |
|----------|---------|-------|-------|
| Dim | Min | Norm | Max |
| A | 4.80 | 5.00 | 5.20 |
| A1 | 2.30 | 2.40 | 2.50 |
| A2 | 1.88 | 1.98 | 2.08 |
| b | 1.10 | 1.20 | 1.30 |
| b1 | 1.20 | / | 1.50 |
| b2 | 2.35 | 2.55 | 2.75 |
| b3 | 2.45 | / | 2.85 |
| c | 0.55 | 0.60 | 0.65 |
| D | 23.3 | 23.45 | 23.6 |
| D1 | 16.25 | 16.55 | 16.85 |
| D2 | 1.00 | / | 1.30 |
| e | TYP2.54 | | |
| e1 | TYP5.06 | | |
| E | 15.75 | 15.90 | 16.05 |
| E1 | 13.80 | / | 14.20 |
| E2 | 4.40 | 4.75 | 5.10 |
| E3 | 13.00 | / | 13.45 |
| L | 17.34 | 17.49 | 17.64 |
| L1 | 4.00 | / | 4.30 |
| L2 | 2.35 | / | 2.65 |
| L3 | TYP1.98 | | |
| Q | 5.60 | 5.80 | 6.00 |
| S | 6.05 | / | 6.30 |
| p | TYP3.58 | | |
| p1 | TYP7.18 | | |
| p2 | TYP3.00 | | |



YJD206560NCFG1Q

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